

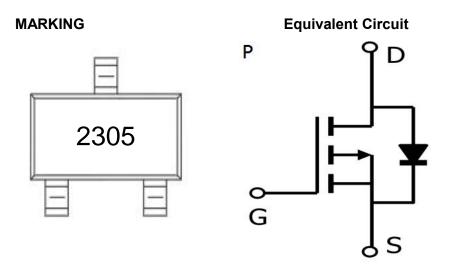
# SOT-23 Plastic-Encapsulate MOSFETS P-Channel 12-V( D-S) MOSFET

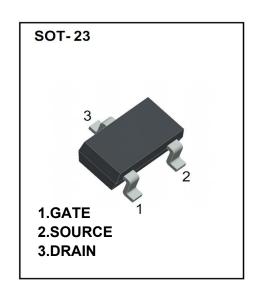
### **FEATURE**

TrenchFET Power MOSFET

#### **APPLICATIONS**

- Load Switch for Portable Devices
- DC/DC Converter





## Maximum ratings (T<sub>a</sub>=25℃ unless otherwise noted)

Parameter	Symbol	Value	Unit	
Drain-Source Voltage	V <sub>DS</sub>	-12	V	
Gate-Source Voltage	$V_{GS}$	±8		
Continuous Drain Current	I <sub>D</sub>	-4.1	^	
Continuous Source-Drain Diode Current	Is	-0.8	A	
Maximum Power Dissipation	P <sub>D</sub>	0.35	W	
Thermal Resistance from Junction to Ambient(t≤10s)	$R_{\theta JA}$	357	°C/W	
Junction Temperature	TJ	150	°C	
Storage Temperature	T <sub>STG</sub>	-50 ~+150	C	

www.tw-gmc.com



# Electrical characteristics ( $T_a$ =25°C unless otherwise noted)

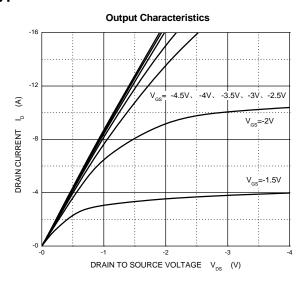
Parameter	Symbol	Test Condition	Min	Тур	Max	Units	
Static							
Drain-source breakdown voltage	V(BR)DSS	$V_{(BR)DSS}$ $V_{GS} = 0V$ , $I_D = -250\mu A$				.,,	
Gate-source threshold voltage	VGS(th)	VDS =V <sub>GS</sub> , ID =-250μA	-0.5		-0.9	V	
Gate-source leakage	I <sub>GSS</sub>	Vps =0V, Vgs =±8V			±100	nA	
Zero gate voltage drain current	I <sub>DSS</sub>	Vps =-8V, Vgs =0V			-1	μΑ	
Drain-source on-state resistance <sup>a</sup>	RDS(on)	Vgs =-4.5V, Ip =-3.5A			0.045	_	
		Vgs =-2.5V, Ip =-3A			0.060		
		Vgs =-1.8V,Ip=-2.0A			0.090		
Forward transconductance <sup>a</sup>	<b>g</b> fs	Vps =-5V, lp =-4.1A	6			S	
Dynamic	•			ı	JI.	I.	
Input capacitance <sup>b,c</sup>	C <sub>iss</sub>			740		pF	
Output capacitance <sup>b,c</sup>	Coss	Vps =-4V,Vgs =0V,f =1MHz		290			
Reverse transfer capacitance <sup>b,c</sup>	C <sub>rss</sub>			190			
Total gate charge <sup>b</sup>		V <sub>DS</sub> =-4V,V <sub>GS</sub> =-4.5V,		7.8	15	nC	
	$Q_g$	ID =-4.1A					
		\\\ \(\lambda\)\\\\ \(\O \)\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\		4.5	9		
Gate-source charge <sup>b</sup>	Q <sub>gs</sub>	V <sub>DS</sub> =-4V,V <sub>GS</sub> =-2.5V,		1.2			
Gate-drain charge <sup>b</sup>	$Q_{gd}$	- ID =-4.1A		1.6			
Gate resistance <sup>b,c</sup>	Rg	f =1MHz	1.4	7	14	Ω	
Turn-on delay time <sup>b,c</sup>	td(on)			13	20	ns	
Rise time <sup>b,c</sup>	tr	V <sub>DD</sub> =-4V,		35	53		
Turn-off Delay time <sup>b,c</sup>	td(off)	R <sub>L</sub> =1.2Ω, I <sub>D</sub> ≈-3.3A, V <sub>GEN</sub> =-4.5V,Rg=1Ω		32	48		
Fall time <sup>b,c</sup>	tf	- V <sub>GEN</sub> =-4.5V,Kg=112		10	20		
Turn-on delay time <sup>b,c</sup>	td(on)			5	10		
Rise time <sup>b,c</sup>	tr	V <sub>DD</sub> =-4V,		11	17		
Turn-off delay time <sup>b,c</sup>	td(off)	R <sub>L</sub> =1.2Ω, I <sub>D</sub> ≈-3.3A,		22	33		
Fall time <sup>b,c</sup>	tf	$V_{GEN}$ =-8V,Rg=1 $\Omega$		16	24		
Drain-source body diode characteristic	s				•		
Continuous source-drain diode current	Is	T <sub>C</sub> =25℃			-1.4	A	
Pulse diode forward current <sup>a</sup>	I <sub>SM</sub>				-10		
Body ciode voltage	V <sub>SD</sub>	I <sub>F</sub> =-3.3A		-0.8	-1.2	V	

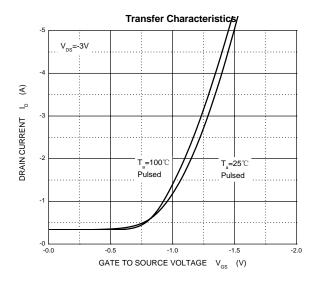
## Note:

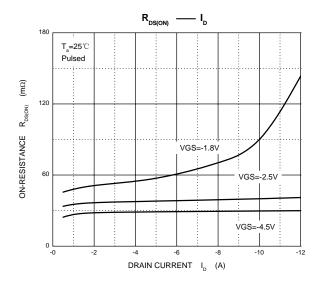
- a. Pulse Test ; Pulse Width ≤300µs, Duty Cycle ≤2%.
- b. Guaranteed by design, not subject to production testing.
- c. These parameters have no way to verify.

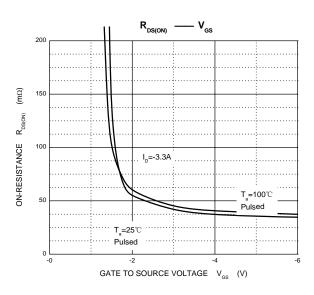


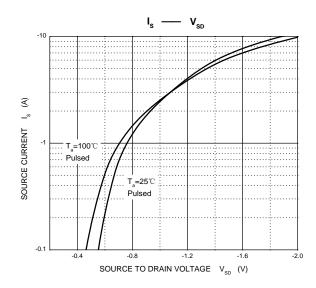
## **Typical Characteristics**

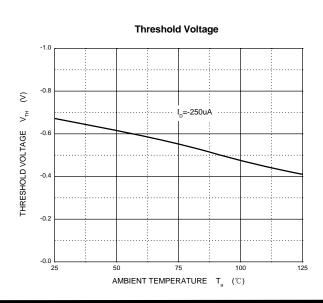










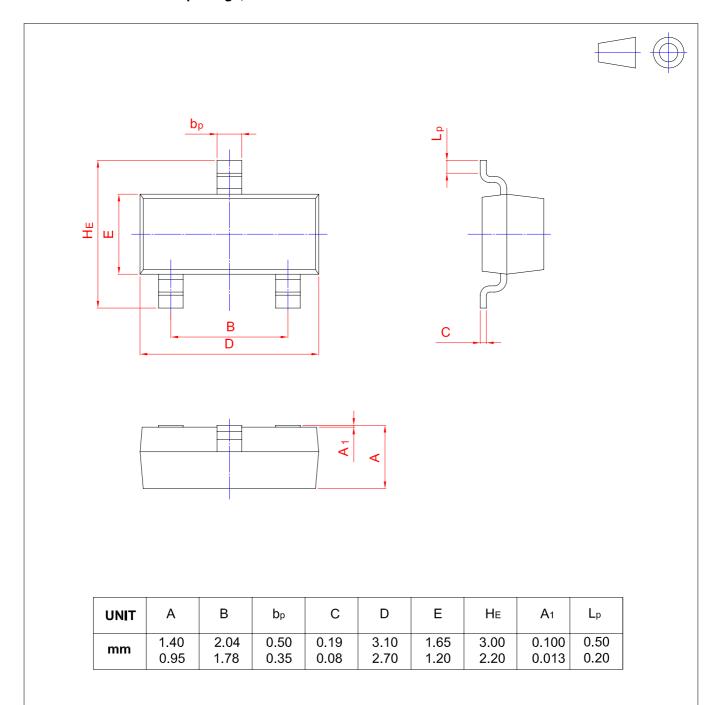




## **PACKAGE OUTLINE**

## Plastic surface mounted package; 3 leads

**SOT-23** 



4